

8-BIT CONSTANT CURRENT LED SINK DRIVER

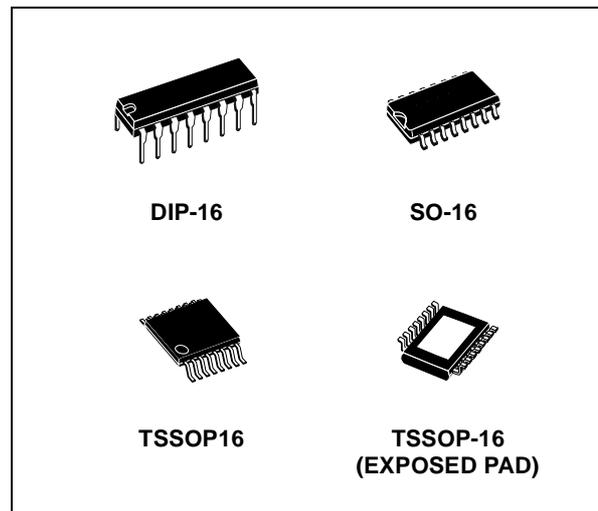
- 8 CONSTANT CURRENT OUTPUT CHANNELS
- ADJUSTABLE OUTPUT CURRENT THROUGH EXTERNAL RESISTOR
- SERIAL DATA IN/PARALLEL DATA OUT
- SERIAL OUT CHANGE STATE ON THE FALLING EDGES OF CLOCK
- OUTPUT CURRENT: 15-120 mA
- 25 MHz CLOCK FREQ.
- AVAILABLE IN HIGH THERMAL TSSOP EXPOSED PAD
- EFFICIENCY PACKAGE

DESCRIPTION

The STP08C596 is a monolithic, medium-voltage, low current power 8-bit shift register designed for LED panel display. The STP08C596 contains a 8-bit serial-in, parallel-out shift register that feeds a 8-bit D-type storage register. In the output stage, sixteen regulated current sources were designed to provide 15-120mA constant current to drive the LEDs.

Compared with the STPIC6C595, the device provides great flexibility and improved performance in LED panel system design.

Trough an external resistor, users may adjust the STP08C596 output current, controlling in this way the light intensity of LEDs.



The STP08C596 guarantees 16V output driving capability, allowing users to connect more LEDs in series. The high clock frequency, 25 MHz, also satisfies the system requirement of high volume data transmission. Compared with a standard TSSOP package, the TSSOP exposed pad increases heat dissipation capability by a 2.5 factor.

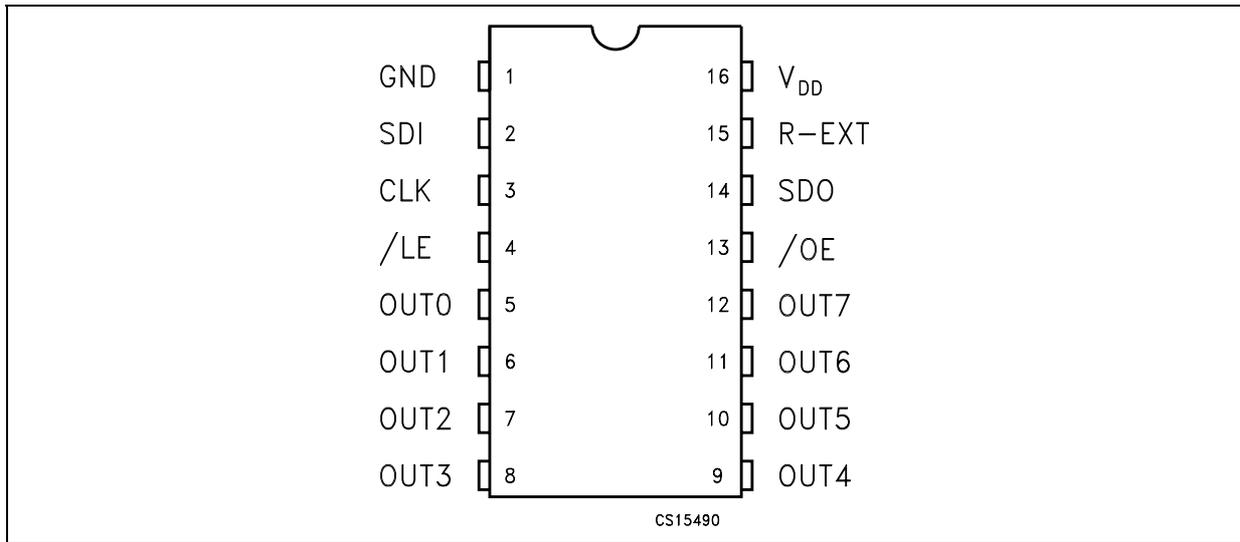
ORDERING CODES

Type	Temp. Range	Package	Comments
STP08C596B1	-40°C to 125°C	DIP-16	25 part per tube
STP08C596M	-40°C to 125°C	SO-16 (Tube)	50 parts per tube
STP08C596MTR	-40°C to 125°C	SO-16 (Tape & Reel)	1000 parts per reel
STP08C596TTR	-40°C to 125°C	TSSOP16 (Tape & Reel)	2500 parts per reel
STP08C596XTTR	-40°C to 125°C	TSSOP-16 Exposed-Pad (Tape & Reel)	2500 parts per reel

CURRENT ACCURACY

Output Voltage	Current accuracy		Output Current
	Between bits	Between ICs	
≥ 0.7V	TYP. ± 3%	± 10%	15 to 120 mA

PIN CONNECTION



PIN DESCRIPTION

PIN N°	Symbol	Name and Function
1	GND	Ground Terminal
2	SDI	Serial data input terminal
3	CLK	Clock input terminal
4	/LE	Latch input terminal
5-12	OUT 0-7	Output terminal
13	/OE	Output enable input terminal (active low)
14	SDO	Serial data out terminal
15	R-EXT	Constant Current programming
16	V _{DD}	5V Supply voltage terminal

EQUIVALENT CIRCUIT OF INPUTS AND OUTPUTS

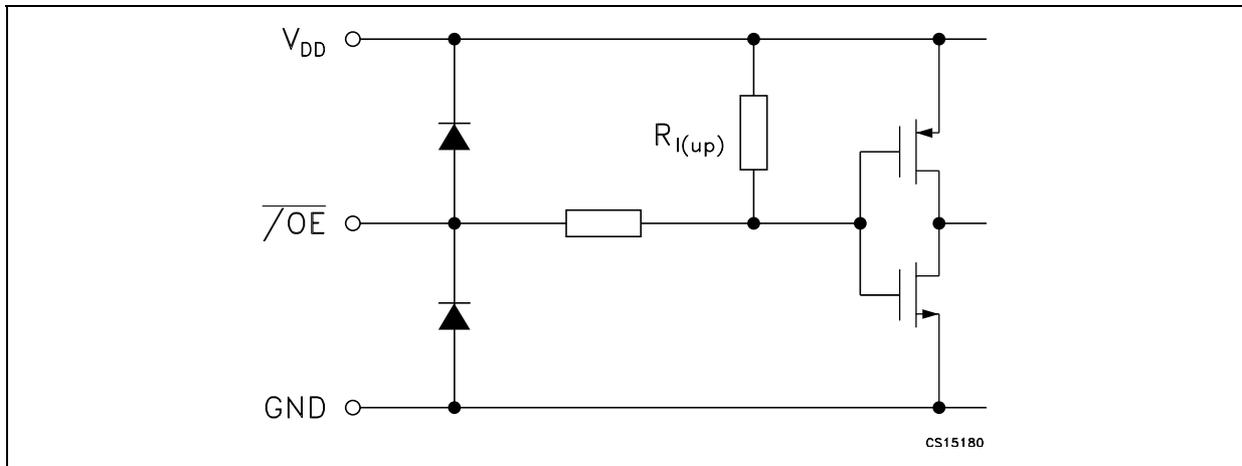
Figure 1 : \overline{OE} Terminal

Figure 2 : /LE Terminal

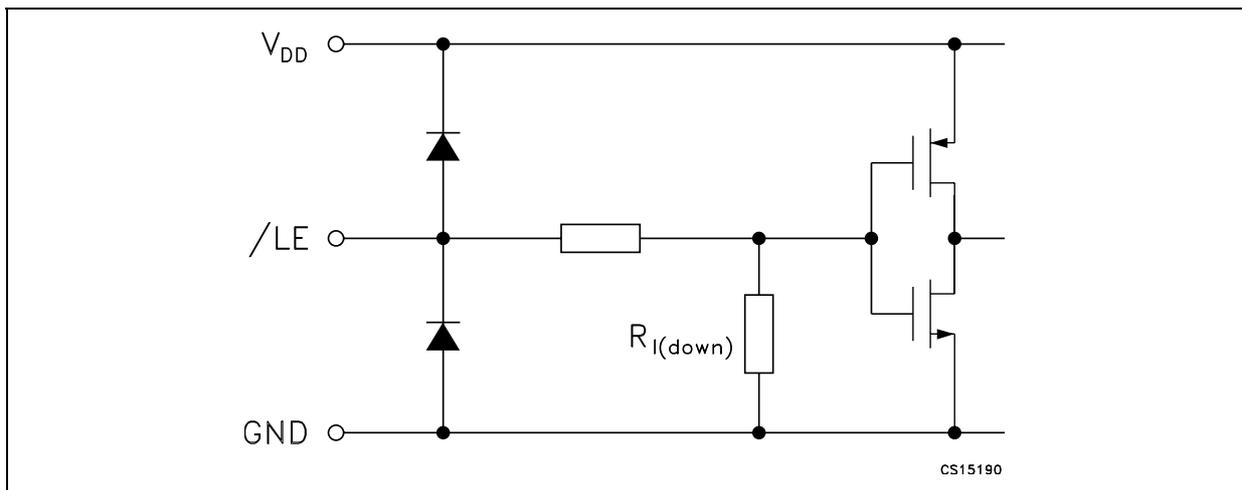


Figure 3 : CLK, SDI Terminal

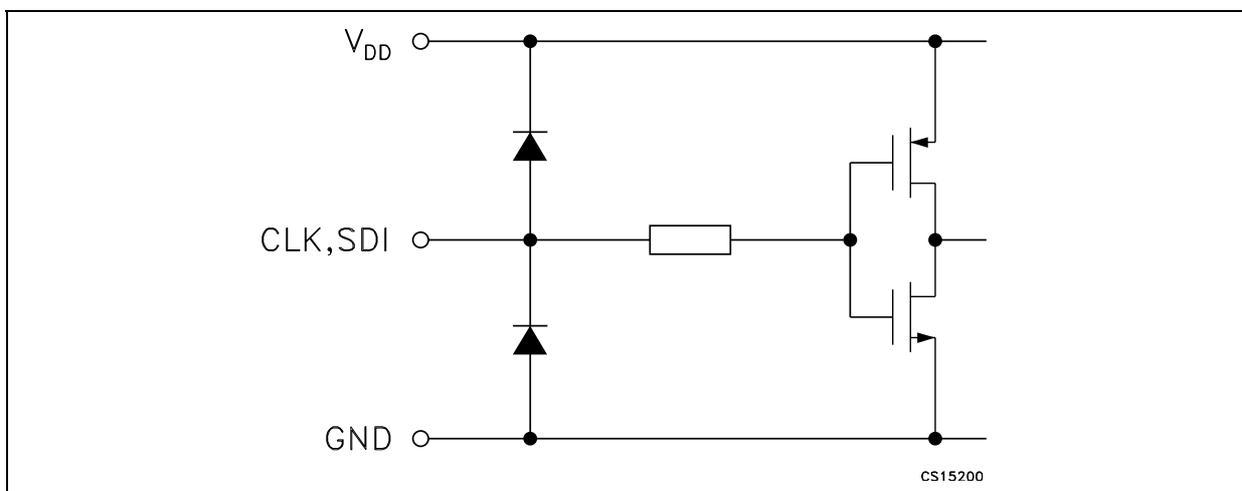
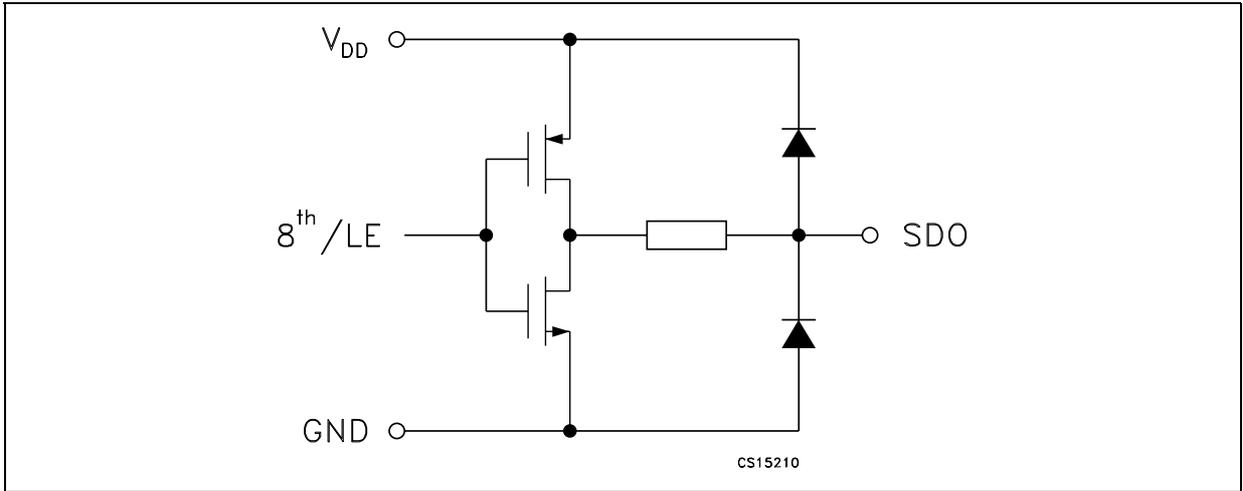
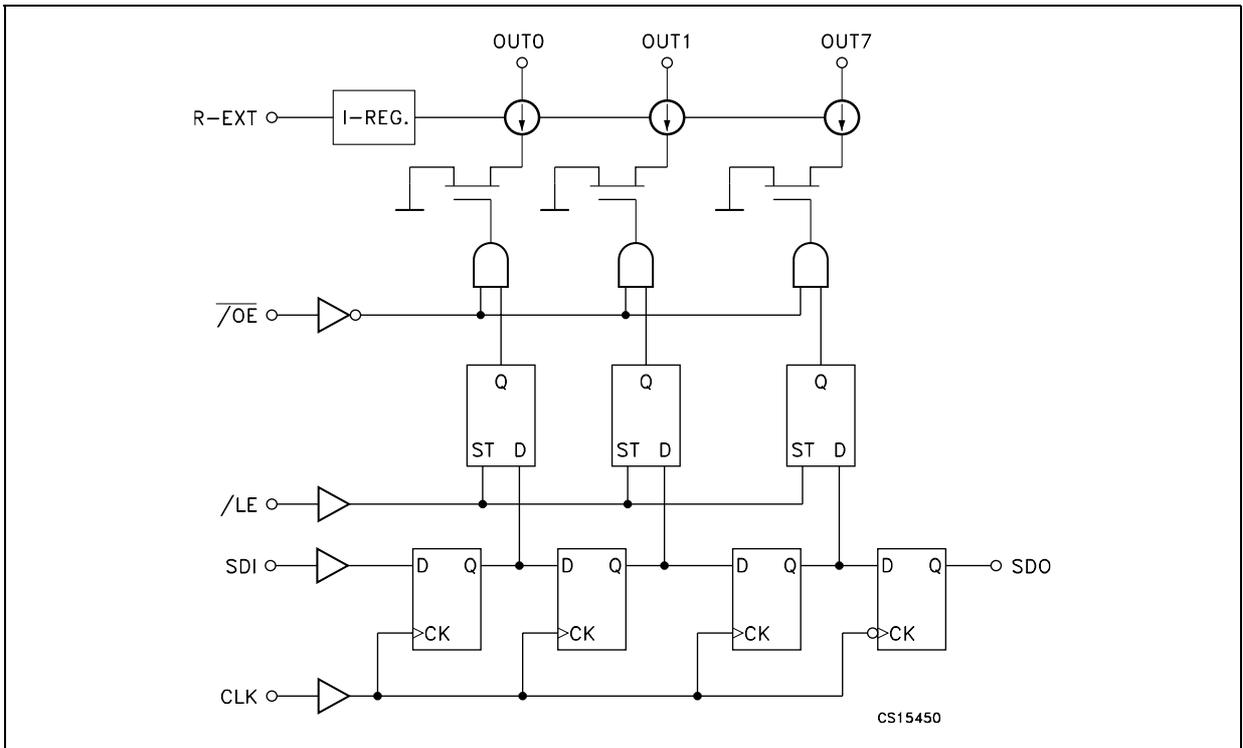


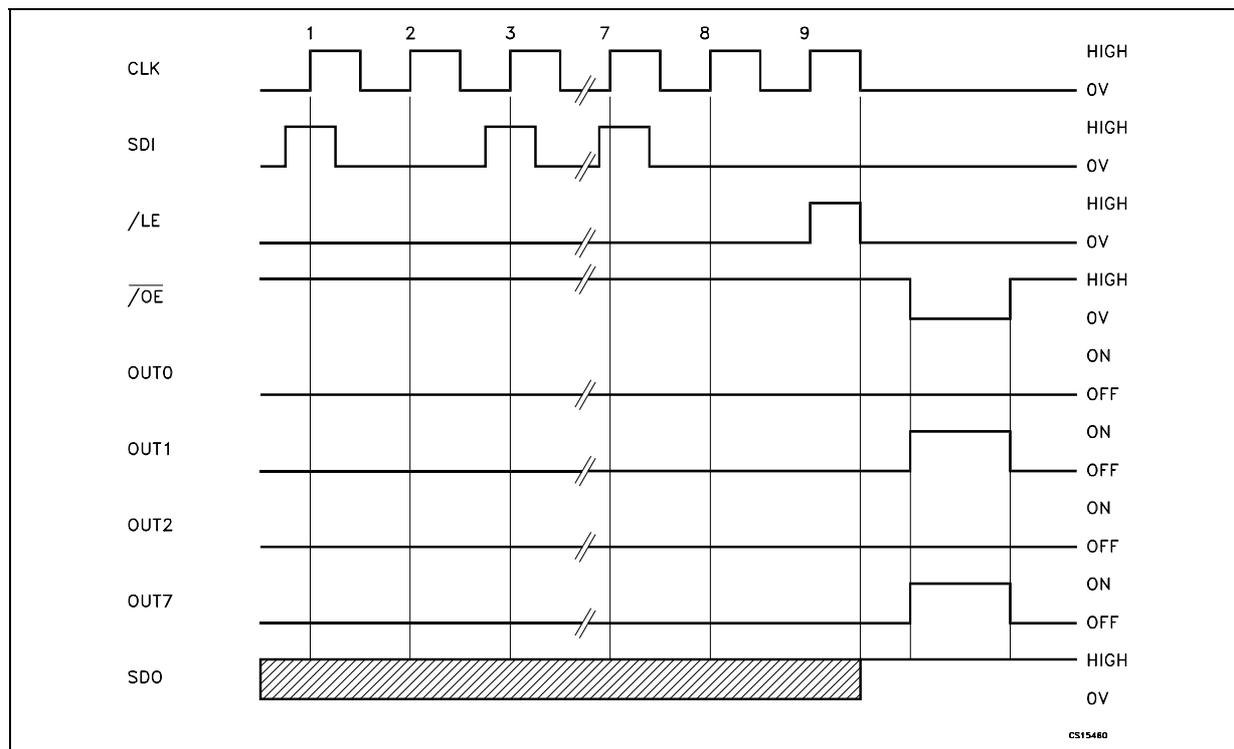
Figure 4 : SDO Terminal



BLOCK DIAGRAM



TIMING DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	0 to 7	V
V_O	Output Voltage	-0.5 to 16	V
I_O	Output Current	120	mA
V_I	Input Voltage	-0.4 to $V_{DD}+0.4$	V
I_{GND}	GND Terminal Current	980	mA
f_{CLK}	Clock Frequency	25	MHz
T_{OPR}	Operating Temperature Range	-40 to +85	°C
T_{STG}	Storage Temperature Range	-55 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

THERMAL DATA

Symbol	Parameter	DIP-16	SO-16	TSSOP-16	TSSOP-16 (exposed pad)	Unit
$R_{thj-amb}$	Thermal Resistance Junction-ambient	90	125	140	37.6	°C/W

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{DD}	Supply Voltage		3.0	3.3	3.6	V
V_O	Output Voltage				16.0	V
I_O	Output Current	OUTn	15		120	mA
I_{OH}	Output Current	SERIAL-OUT			+1	mA
I_{OL}	Output Current	SERIAL-OUT			-1	mA
V_{IH}	Input Voltage		$0.7V_{DD}$		$V_{DD}+0.3$	V
V_{IL}	Input Voltage		-0.3		$0.3V_{DD}$	V
t_{wLAT}	/LE Pulse Width	$V_{DD} = 3.0$ to $3.6V$	20			ns
t_{wCLK}	CLK Pulse Width		20			ns
t_{wEN}	/OE Pulse Width		400			ns
$t_{SETUP(D)}$	Setup Time for DATA		20			ns
$t_{HOLD(D)}$	Hold Time for DATA		15			ns
$t_{SETUP(L)}$	Setup Time for LATCH		15			ns
$t_{HOLD(E)}$	Hold Time for ENABLE		60			ns
f_{CLK}	Clock Frequency		Cascade Operation			25

ELECTRICAL CHARACTERISTICS ($V_{DD}=5V$, $T = 25^{\circ}C$, unless otherwise specified.)

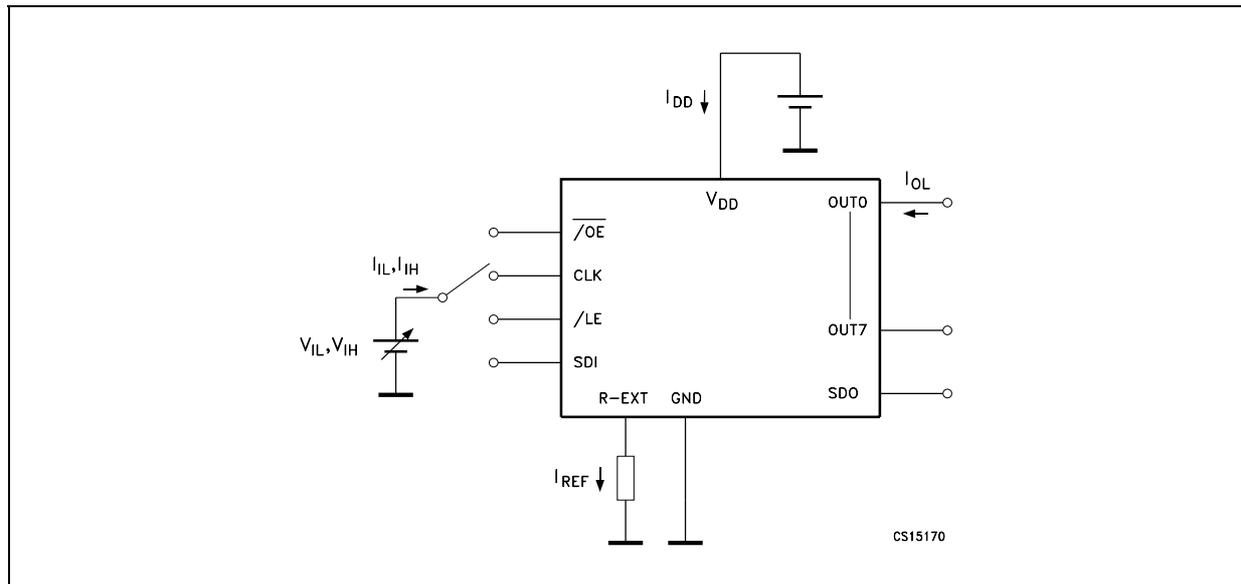
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{IH}	Input Voltage High Level		$0.7V_{DD}$		V_{DD}	V
V_{IL}	Input Voltage Low Level		GND		$0.3V_{DD}$	V
I_{OH}	Output Leakage Current	$V_{OH} = 16V$			10	μA
V_{OL}	Output Voltage (Serial-OUT)	$I_{OL} = 1mA$			0.4	V
V_{OH}	Output Voltage (Serial-OUT)	$I_{OH} = -1mA$	$V_{DD}-0.4V$			V
I_{OL1}	Output Current	$V_O = 0.7V$ $R_{EXT} = 910 \Omega$	20.6	20.7	20.9	mA
I_{OL2}		$V_O = 0.7V$ $R_{EXT} = 360 \Omega$	50.6	51.0	51.5	mA
ΔI_{OL1}	Output Current Error between bit (All Output ON)	$V_O = 0.7V$ $R_{EXT} = 910 \Omega$			± 3	%
ΔI_{OL2}		$V_O = 0.7V$ $R_{EXT} = 360 \Omega$			± 3	%
$R_{SIN(up)}$	Pull-up Resistor		150	300	600	K Ω
$R_{SIN(down)}$	Pull-down Resistor		100	200	400	K Ω
$I_{DD(OFF1)}$	Supply Current (OFF)	$R_{EXT} = OPEN$ OUT 0 to 15 = OFF		0.3	0.6	mA
$I_{DD(OFF2)}$		$R_{EXT} = 470 \Omega$ OUT 0 to 15 = OFF		5.5	7.7	
$I_{DD(OFF3)}$		$R_{EXT} = 250 \Omega$ OUT 0 to 15 = OFF		10.1	14.1	
$I_{DD(ON1)}$	Supply Current (ON)	$R_{EXT} = 470 \Omega$ OUT 0 to 15 = ON		5.5	7.7	mA
$I_{DD(ON2)}$		$R_{EXT} = 250 \Omega$ OUT 0 to 15 = ON		10.1	14.1	

SWITCHING CHARACTERISTICS ($V_{DD}=5V$, $T = 25^{\circ}C$, unless otherwise specified.)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_{PLH1}	Propagation Delay Time, CLK-OUTn, /LE = H, /OE = L	$V_{DD} = 3V$ $V_{IH} = V_{DD}$ $V_{IL} = GND$ $C_L = 13pF$		250	280	ns
t_{PLH2}	Propagation Delay Time, /LE-OUTn, /OE = L	$I_O = 40mA$ $V_L = 3V$		250	280	ns
t_{PLH3}	Propagation Delay Time, /OE-OUTn, /LE = H	$R_{EXT} = 470\Omega$ $R_L = 65\Omega$		250	280	ns
t_{PLH}	Propagation Delay Time, CLK-SDO			25	35	ns
t_{PHL1}	Propagation Delay Time, CLK-OUTn, /LE = H, /OE = L			40	60	ns
t_{PHL2}	Propagation Delay Time, /LE-OUTn, /OE = L			30	50	ns
t_{PHL3}	Propagation Delay Time, /OE-OUTn, /LE = H			60	70	ns
t_{PHL}	Propagation Delay Time, CLK-SDO			30	40	ns
t_r	Output Rise Time			280		ns
t_f	Output Fall Time			20		ns

TEST CIRCUIT

DC Characteristic



AC Characteristic

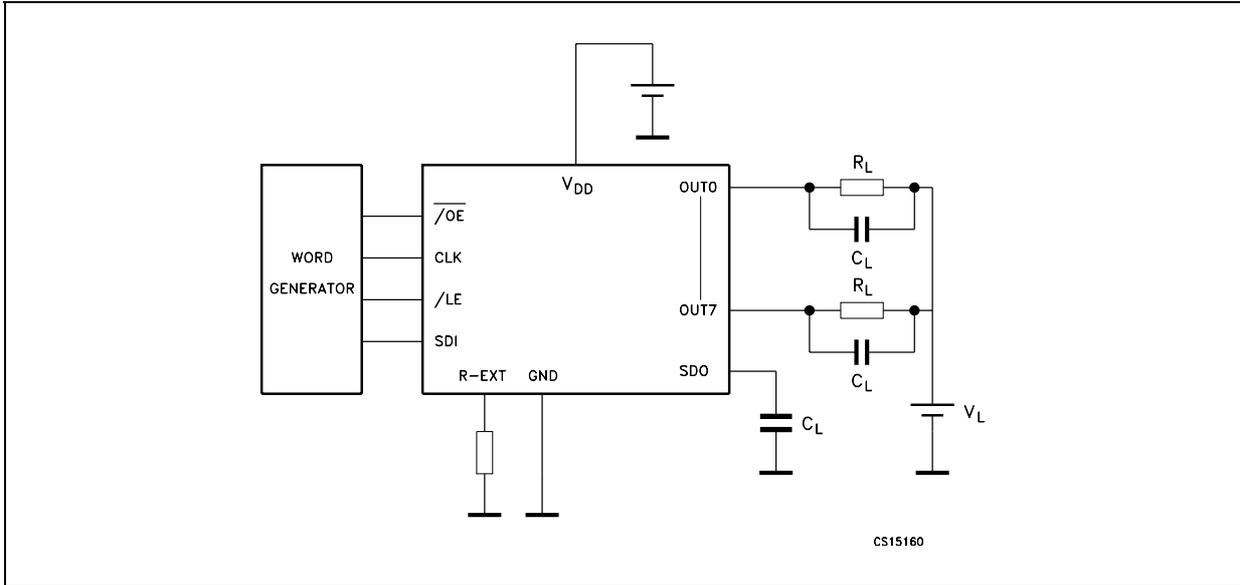


Figure 5 : Output Current- R_{EXT} Resistor

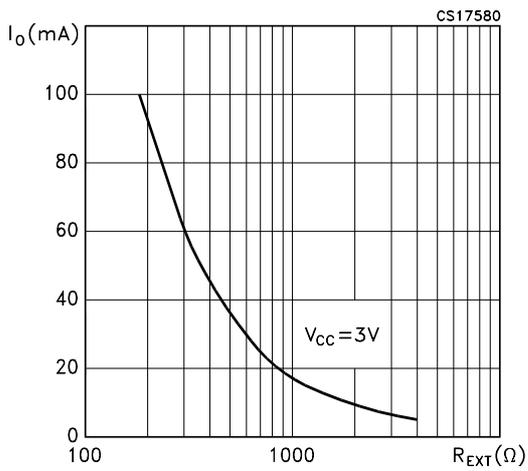
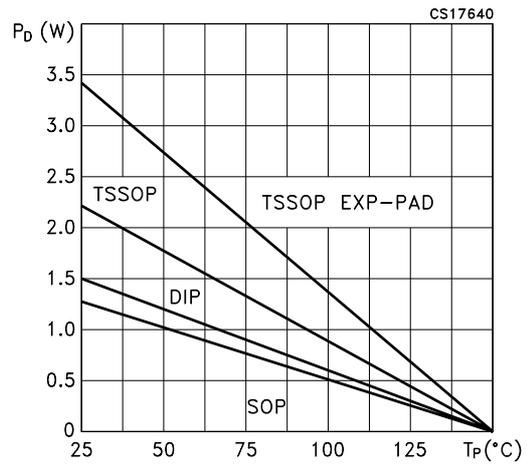
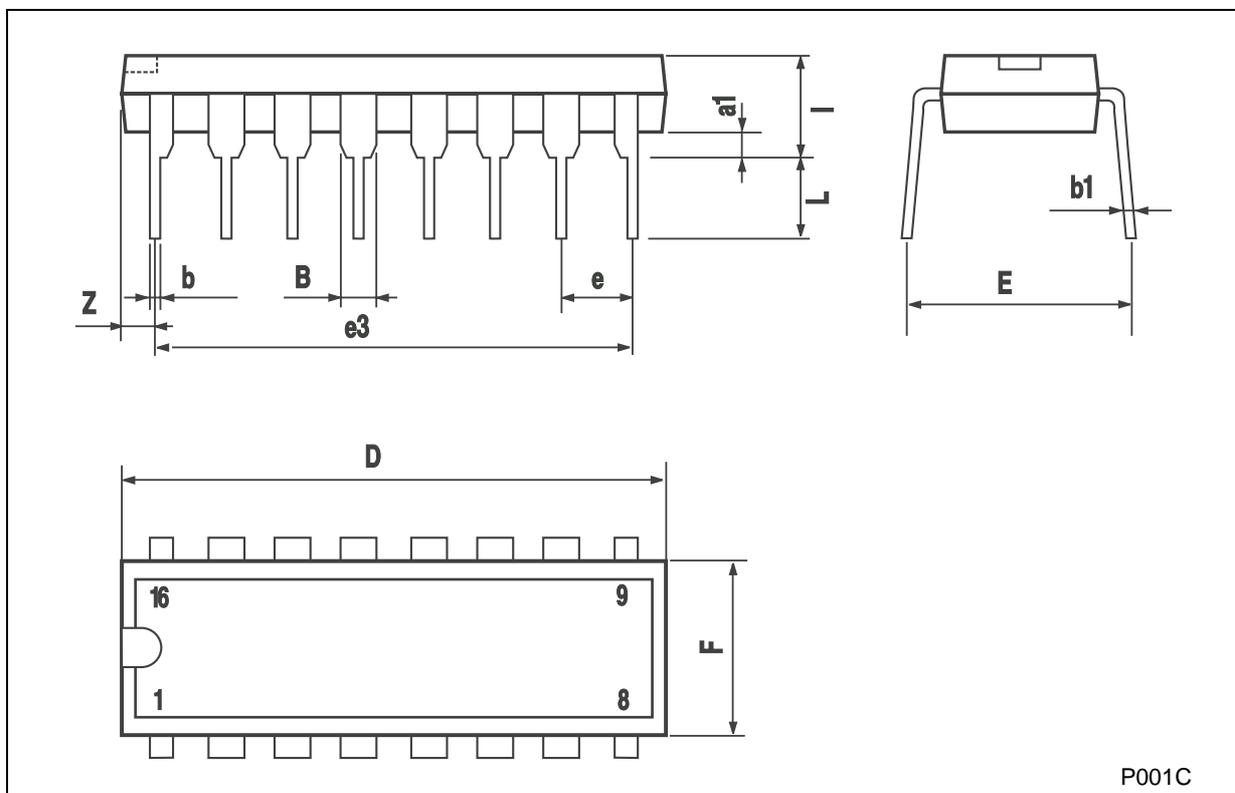


Figure 6 : Power Dissipation vs Temperature Package



Plastic DIP-16 (0.25) MECHANICAL DATA

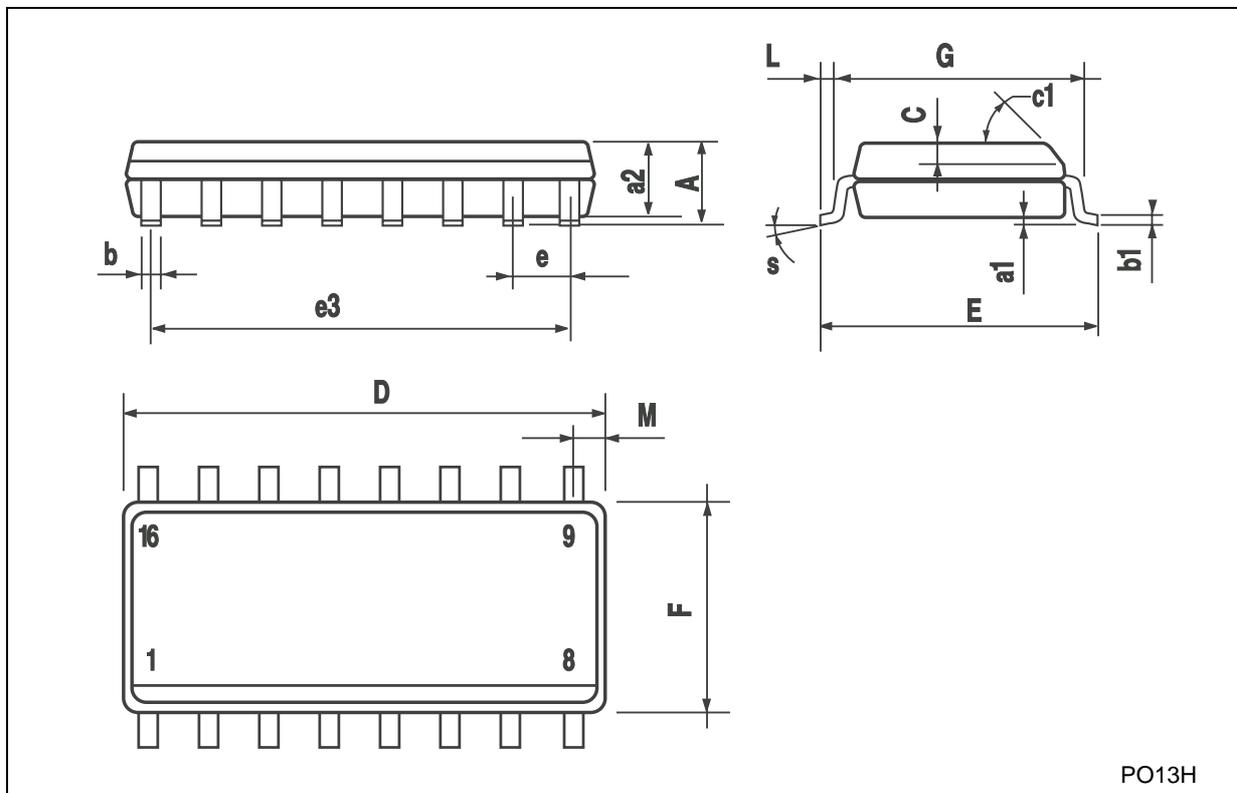
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050



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SO-16 MECHANICAL DATA

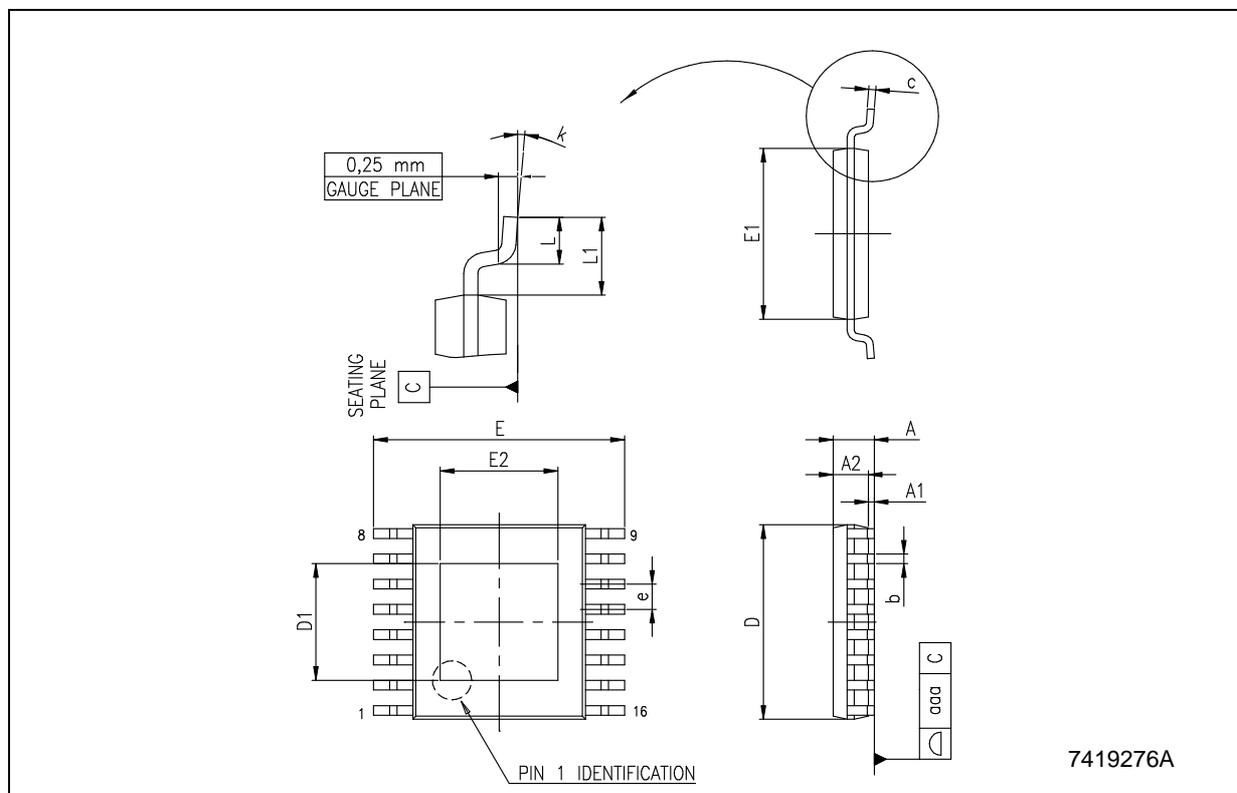
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.004		0.008
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.62			0.024
S	8			° (max.)		



PO13H

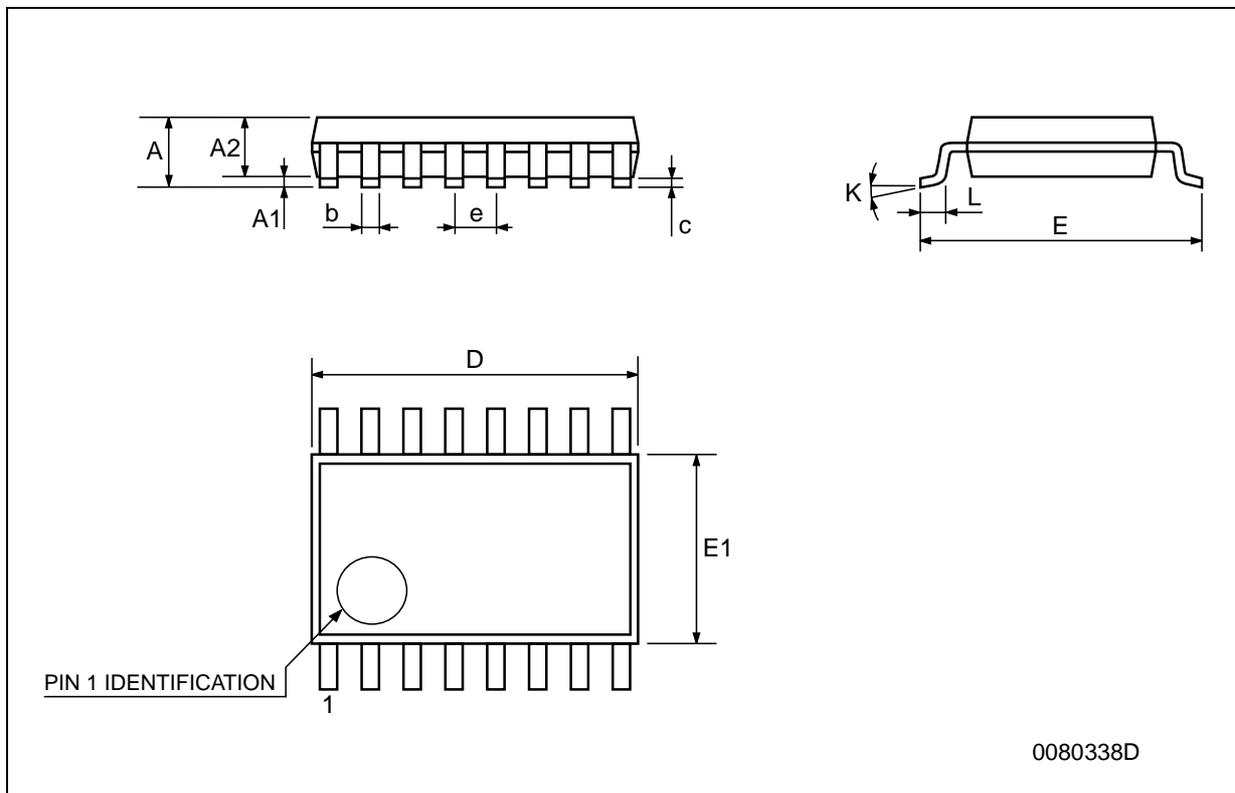
TSSOP16 EXPOSED PAD MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1			0.15		0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
D1	1.7			0.067		
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.5	0.169	0.173	0.177
E2	1.5			0.059		
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



TSSOP16 MECHANICAL DATA

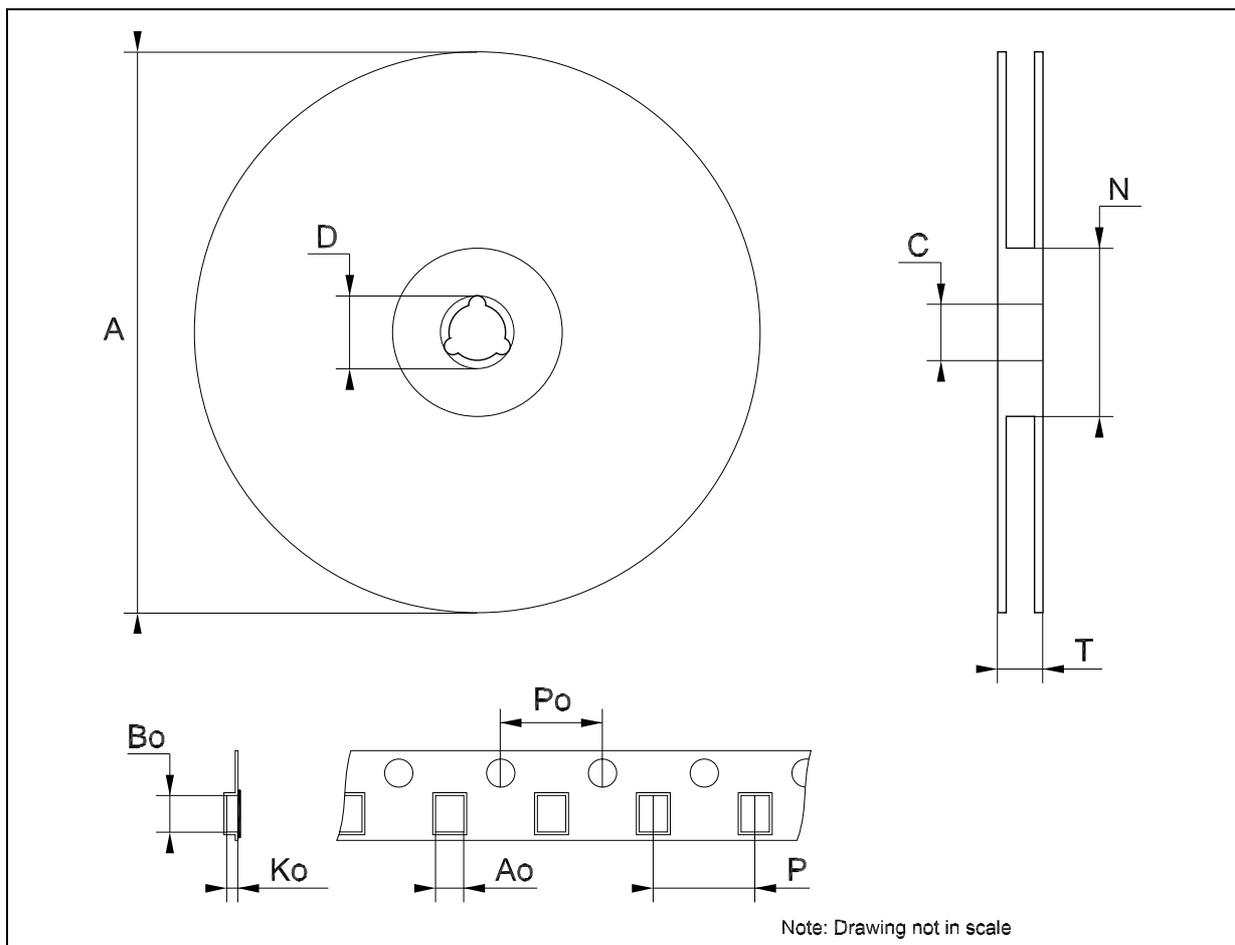
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



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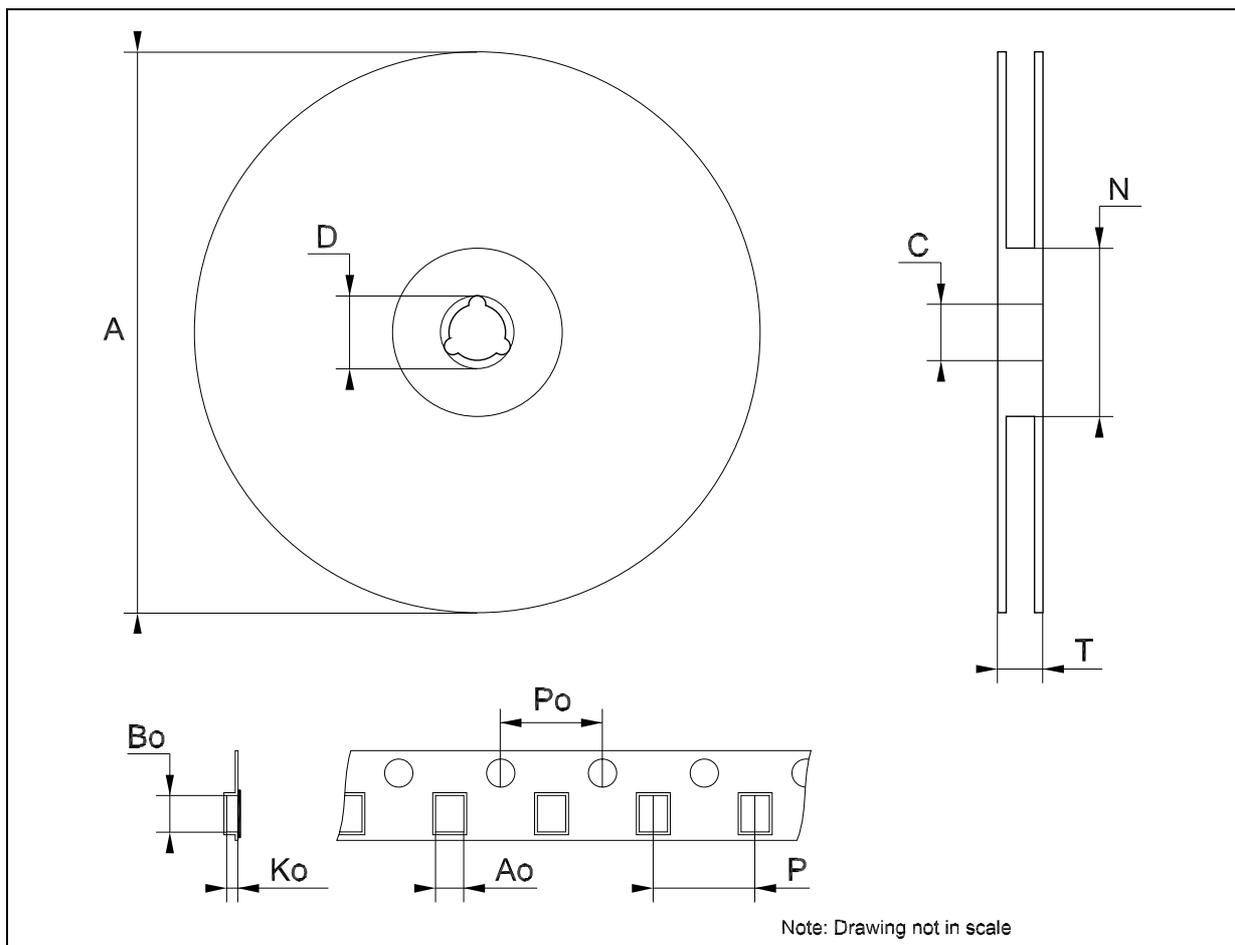
Tape & Reel SO-16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.45		6.65	0.254		0.262
Bo	10.3		10.5	0.406		0.414
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



Tape & Reel TSSOP16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Bo	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



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